



95SQ015 SCHOTTKY RECTIFIER

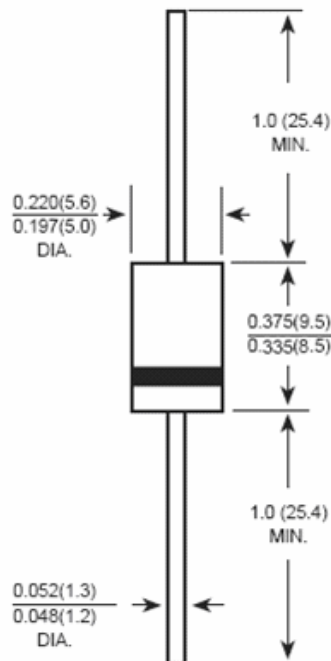
Applications:

- Parallel switching power supply
- Converters
- Redundant power subsystems
- Reverse battery protection

Features:

- 125 °C T_J operation (V_R<5V)
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- Optimized for OR-ing applications
- Ultra low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- This is a Pb – Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

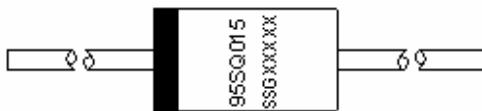
Mechanical Dimensions: In Inches / mm



DO-201AD



Marking Diagram:



Where XXXXX is YYWWL

95SQ015 = Part Name
SSG = SSG
YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Ordering Information:

Device	Package	Shipping
95SQ015	DO-201AD (Pb-Free)	1250pcs / tape

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	V_{RWM}	-	15 (DC) 25 (Working)	V
Max. Average Forward Current	$I_{F(AV)}$	50% duty cycle @ $T_C = 55^\circ C$, rectangular wave form	9	A
Max. Peak One Cycle Non-Repetitive Surge Current (per leg)	I_{FSM}	8.3 ms, half Sine pulse	480	A
Non-Repetitive Avalanche Energy (per leg)	E_{AS}	$T_J = 25^\circ C$, $I_{AS} = 1 A$, $L = 9.0 mH$	4.5	mJ
Repetitive Avalanche Current (per leg)	I_{AR}	Current decaying linearly to zero in 1 μsec Frequency limited by T_J max. $V_A = 3 \times V_R$ typical	1	A



Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop	V_{F1}	@ 9 A, Pulse, $T_J = 25\text{ }^\circ\text{C}$	0.34	V
		@ 18 A, Pulse, $T_J = 25\text{ }^\circ\text{C}$	0.37	
	V_{F2}	@ 9 A, Pulse, $T_J = 125\text{ }^\circ\text{C}$	0.25	V
		@ 18 A, Pulse, $T_J = 125\text{ }^\circ\text{C}$	0.31	
Max. Reverse Current	I_{R1}	@ $V_R = \text{rated } V_R, T_J = 25\text{ }^\circ\text{C}$	7.0	mA
	I_{R2}	@ $V_R = \text{rated } V_R, T_J = 100\text{ }^\circ\text{C}$	348	mA
	I_{R3}	@ $V_R = 12\text{ V}, T_J = 100\text{ }^\circ\text{C}$	310	mA
	I_{R4}	@ $V_R = 5\text{ V}, T_J = 100\text{ }^\circ\text{C}$	190	mA
Typical Junction Capacitance	C_T	@ $V_R = 5.0\text{ V}, T_c = 25\text{ }^\circ\text{C}$ $f_{SIG} = 1\text{ MHz}$	1300	pF
Typical Series Inductance (per leg)	L_S	Measured lead to lead 5 mm from package body	8.0	nH
Max. Voltage Rate of Change	dv/dt	-	10,000	V/ μs

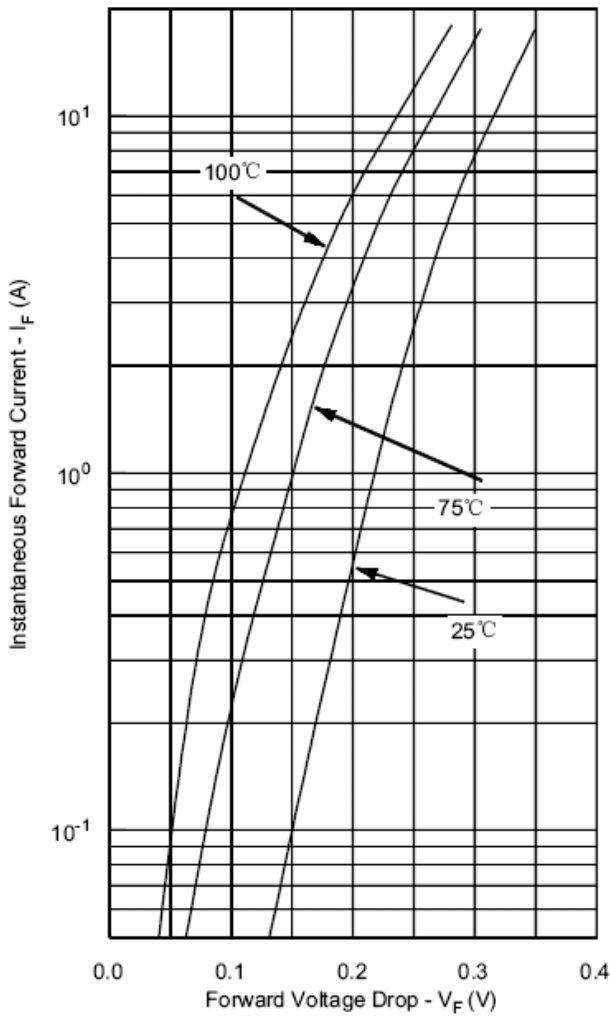
* Pulse Width < 300 μs , Duty Cycle < 2%

Thermal-Mechanical Specifications:

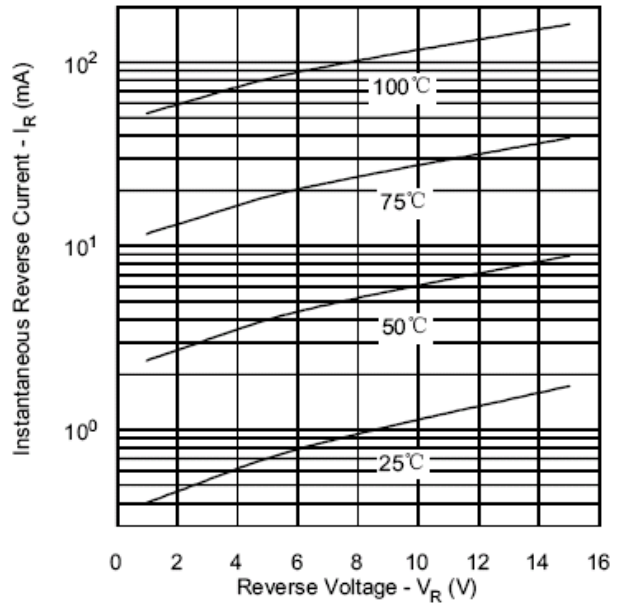
Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	T_J	-	-55 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-	-55 to +150	$^\circ\text{C}$
Maximum Thermal Resistance, Case to Heat Sink	$R_{\theta JA}$	-	44	$^\circ\text{C/W}$
Maximum Thermal Resistance, Junction to lead	$R_{\theta JL}$	-	8	$^\circ\text{C/W}$
Approximate Weight	wt	-	1.02	g
Case Style	DO-201AD			



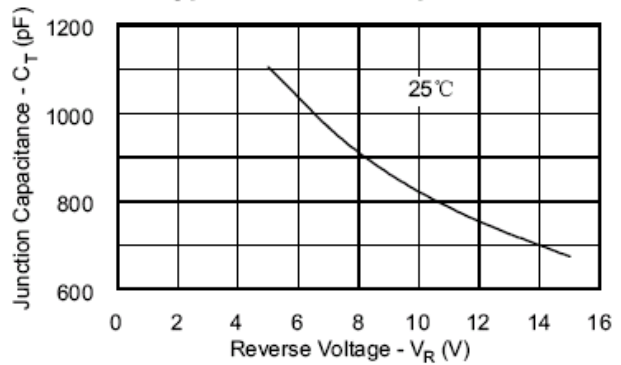
Typical Forward Characteristics



Typical Reverse Characteristics



Typical Junction Capacitance





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